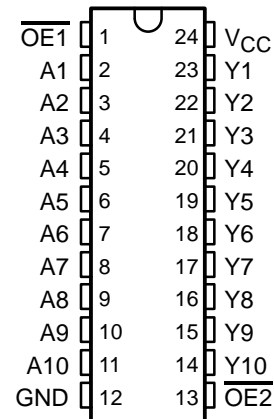


SN74LVC828A 10-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

SCAS347D – MARCH 1994 – REVISED MAY 1997

- **EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process**
- **Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$**
- **Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$**
- **Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages**

DB, DW, OR PW PACKAGE
(TOP VIEW)



description

This 10-bit buffer/bus driver is designed for 2.7-V to 3.6-V V_{CC} operation.

The SN74LVC828A provides a high-performance bus interface for wide datapaths or buses carrying parity.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable ($\overline{OE1}$ or $\overline{OE2}$) input is high, all ten outputs are in the high-impedance state. The SN74LVC828A provides inverting data at its outputs.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74LVC828A is characterized for operation from -40°C to 85°C .

FUNCTION TABLE

| INPUTS | | | OUTPUT |
|------------------|------------------|---|--------|
| $\overline{OE1}$ | $\overline{OE2}$ | A | Y |
| L | L | L | H |
| L | L | H | L |
| H | X | X | Z |
| X | H | X | Z |



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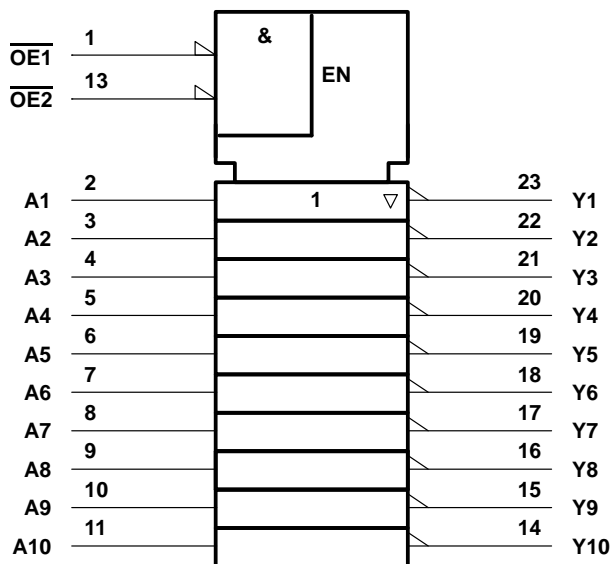
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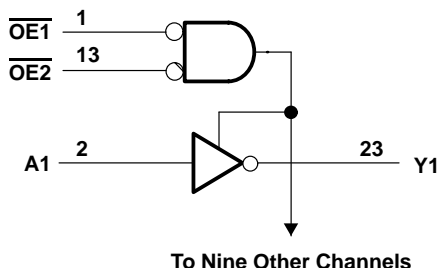
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10-BIT BUFFER/DRIVER
WITH 3-STATE OUTPUTS
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logic symbol†



logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| | |
|---|----------------------------|
| Supply voltage range, V_{CC} | -0.5 V to 6.5 V |
| Input voltage range, V_I (see Note 1) | -0.5 V to 6.5 V |
| Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1) | -0.5 V to 6.5 V |
| Voltage range applied to any output in the high or low state, V_O (see Notes 1 and 2) | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | -50 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) | ± 50 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) (see Note 2) | ± 50 mA |
| Continuous current through V_{CC} or GND | ± 100 mA |
| Package thermal impedance, θ_{JA} (see Note 3): DB package | 104°C/W |
| DW package | 81°C/W |
| PW package | 120°C/W |
| Storage temperature range, T_{stg} | -65°C to 150°C |

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. The value of V_{CC} is provided in the recommended operating conditions table.
 3. The package thermal impedance is calculated in accordance with JESD 51.



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recommended operating conditions (see Note 4)

| | | MIN | MAX | UNIT | |
|-----------------|------------------------------------|----------------------------------|-----|-----------------|----|
| V _{CC} | Supply voltage | Operating | 2 | 3.6 | V |
| | | Data retention only | 1.5 | | |
| V _{IH} | High-level input voltage | V _{CC} = 2.7 V to 3.6 V | | V | |
| V _{IL} | Low-level input voltage | V _{CC} = 2.7 V to 3.6 V | | V | |
| V _I | Input voltage | 0 | 5.5 | V | |
| V _O | Output voltage | High or low state | 0 | V _{CC} | V |
| | | 3 state | 0 | 5.5 | |
| I _{OH} | High-level output current | V _{CC} = 2.7 V | | -12 | mA |
| | | V _{CC} = 3 V | | -24 | |
| I _{OL} | Low-level output current | V _{CC} = 2.7 V | | 12 | mA |
| | | V _{CC} = 3 V | | 24 | |
| Δt/Δv | Input transition rise or fall rate | 0 | 10 | ns/V | |
| T _A | Operating free-air temperature | -40 | 85 | °C | |

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | MIN | TYP† | MAX | UNIT |
|------------------|--|-----------------|----------------------|------|------|------|
| V _{OH} | I _{OH} = -100 μA | 2.7 V to 3.6 V | V _{CC} -0.2 | | | V |
| | I _{OH} = -12 mA | 2.7 V | 2.2 | | | |
| | | 3 V | 2.4 | | | |
| | I _{OH} = -24 mA | 3 V | 2.2 | | | |
| V _{OL} | I _{OL} = 100 μA | 2.7 V to 3.6 V | | | 0.2 | V |
| | I _{OL} = 12 mA | 2.7 V | | | 0.4 | |
| | I _{OL} = 24 mA | 3 V | | | 0.55 | |
| I _I | V _I = 0 to 5.5 V | 3.6 V | | | ±5 | μA |
| I _{off} | V _I or V _O = 5.5 V | 0 | | | ±10 | μA |
| I _{OZ} | V _O = 0 to 5.5 V | 3.6 V | | | ±10 | μA |
| I _{CC} | V _I = V _{CC} or GND | 3.6 V | I _O = 0 | | 10 | μA |
| | 3.6 V ≤ V _I ≤ 5.5 V‡ | | | | 10 | |
| ΔI _{CC} | One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND | 2.7 V to 3.6 V | | | 500 | μA |
| C _i | V _I = V _{CC} or GND | 3.3 V | | 5 | | pF |
| C _o | V _O = V _{CC} or GND | 3.3 V | | 7 | | pF |

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ This applies in the disabled state only.



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switching characteristics over recommended operating free-air temperature range, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 3.3 V \pm 0.3 V$ | | $V_{CC} = 2.7 V$ | | UNIT |
|---------------------|-----------------|-------------|----------------------------|-----|------------------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| t_{pd} | A | Y | 1 | 6.7 | 7.1 | | ns |
| t_{en} | \overline{OE} | Y | 1 | 7.3 | 8.5 | | ns |
| t_{dis} | \overline{OE} | Y | 1.8 | 6.7 | 7.3 | | ns |
| $t_{sk(o)}^\dagger$ | | | | 1 | | | ns |

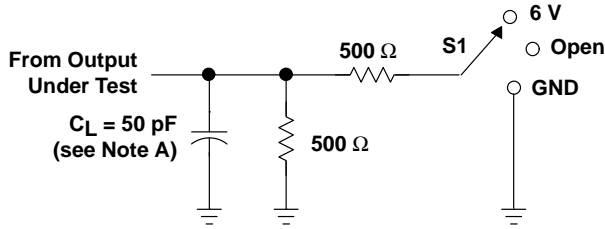
† Skew between any two outputs of the same package switching in the same direction. This parameter is warranted but not production tested.

operating characteristics, $V_{CC} = 3.3 V$, $T_A = 25^\circ C$

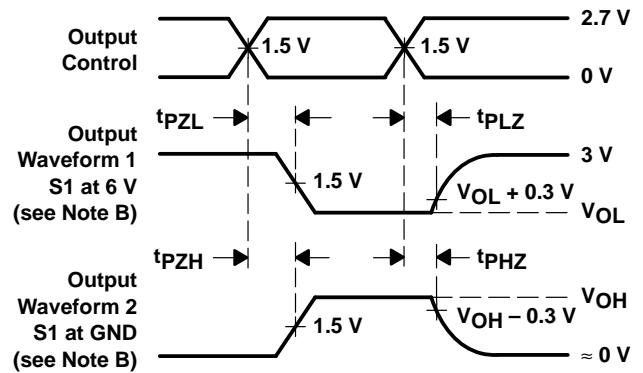
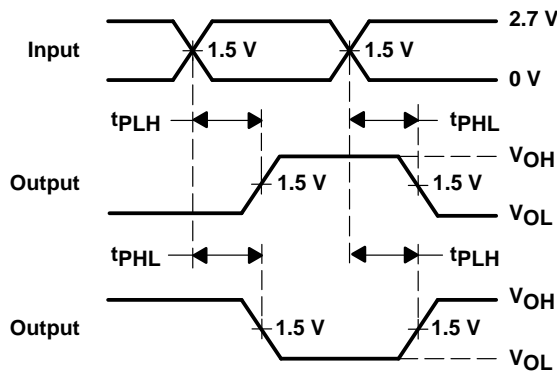
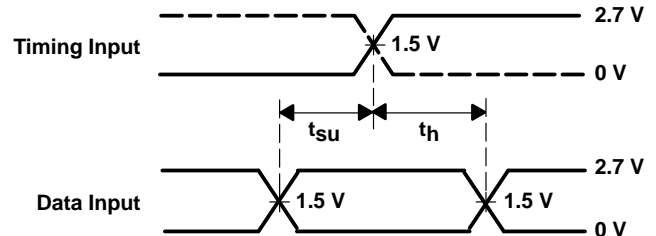
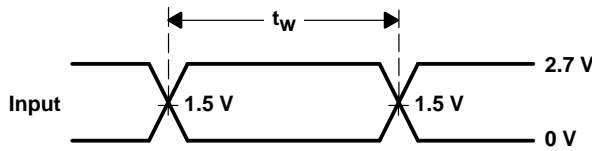
| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|-----------|---|--------------------------|-----|------|
| C_{pd} | Power dissipation capacitance per buffer/driver | $C_L = 0$, $f = 10$ MHz | 24 | pF |
| | | | 7 | |



PARAMETER MEASUREMENT INFORMATION



| TEST | S1 |
|-------------------|------|
| t_{pd} | Open |
| t_{PLZ}/t_{PZL} | 6 V |
| t_{PHZ}/t_{PZH} | GND |



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.
 D. The outputs are measured one at a time with one transition per measurement.
 E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 F. t_{PZL} and t_{PZH} are the same as t_{en} .
 G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

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